



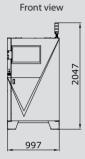
iS6052 THT

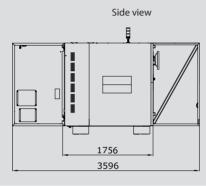
Solder joint inspection on PCB top sides

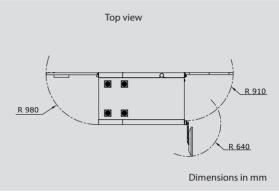




Technical Specifications iS6052 THT







		iS6052 THT
Inspection scope		2D placement
Camera technology		XMe THT
	Angled view cameras	
	Number of megapixel cameras	4
	Orthogonal camera	
	Resolution	12 μm
	Field of view	50 mm x 50 mm (1.9" x 1.9")
Inspection Speed		Up to 60 cm ² /s
Software	User interface	Viscom vVision
	Statistical process control	Viscom vSPC/SPC, open interface (optional)
	Verification station	Viscom vVerify
	Remote diagnosis	Viscom SRC (optional)
	Programming station	Viscom PST34 (optional)
System computer	Operating system	Windows®
	Processor	Intel®Core™i7
PCB handling	PCB dimensions	600 mm x 508 mm (23.6" x 20")*
	PCB support	Optional
	Transport height	900 - 950 mm ± 20 mm (35.4" - 37.4" ± 0.7")
	Width adjustment	Automatic
	Transport concept	Single-track transport system
	PCB clamping	Pneumatic
	Upper transport clearance	Up to 115 mm (4.5")
	Lower transport clearance	50 mm (1.9"); 40 mm (1.5") with PCB support
Other system data	Positioning unit	Synchronous linear motor
	Interfaces	SMEMA, Hermes
	Power requirements	230/400 V, 50 Hz, 3P/N/PE +/- 10%; 4 - 6 bar working pressure
	System dimensions	997 mm x 1756 mm x 1753 mm (39.2" x 69.1" x 69") (W x D x H)
	Weight	Approx. 820 – 920 kg (1807.7 – 2028.2 lbs)

Specifications and other system information are subject to change without notice and may differ from the information displayed at the time of ordering.

^{*} PCB dimensions depending on configuration. Long Board Option required. Base configuration is 440 mm x 508 mm. Subject to surcharge